506617078 04/19/2021

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
KEN KOMIYA	04/12/2021

RECEIVING PARTY DATA

Name:	KIOXIA CORPORATION	
Street Address:	1-21, SHIBAURA 3-CHOME	
City:	MINATO-KU, TOKYO	
State/Country:	JAPAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17200283

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ATTORNEY DOCKET NUMBER:	ORNEY DOCKET NUMBER: 20295	
NAME OF SUBMITTER:	SAMUEL SWINDELL	
SIGNATURE:	IATURE: /Samuel Swindell/	
DATE SIGNED:	04/19/2021	
	This document serves as an Oath/Declaration (37 CFR 1.63).	

Total Attachments: 1

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PATENT REEL: 055961 FRAME: 0194

Combined Declaration and Assignment SEMICONDUCTOR MEMORY DEVICE AND METHOD OF MANUFACTURING Title of Invention THEREOF As the below named inventor, I hereby declare that: [] The attached application, or This declaration is directed to: [] United States application or PCT international application Number 17/200,283 filed on March 12, 2021 The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

In consideration of value received, I sell and assign to Kioxia Corporation having a business address at 1-21, Shibaura 3-chome, Minato-ku, Tokyo Japan, its successors, assigns or nominees, hereinafter referred to as "Assignee", my entire right, title and interest in and to said invention, and in and to all applications for patent and patents for said invention, in all countries of the world, including all divisions, reissues, continuations, substitutions and extensions thereof and all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of intellectual property, including rights of priority, resulting from the filing of any of said applications.

I authorize said Assignee to file and prosecute an application or applications for patent for said invention as the applicant, and I request any official whose duty it is to issue patents, to issue any patent on said invention to said Assignee.

I agree that on request and without further consideration, but at the expense of said Assignee, I will communicate to said Assignee or its representatives all facts known to me respecting said invention and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue, or other applications, make all rightful oaths and declarations, and generally do everything possible to aid said Assignee to obtain and enforce proper patent protection for said invention in all countries.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

LEGAL NAME OF INVENTOR

Ken, KOMIYA	Ken Kom:ya	Apr.12, 2021
Inventor (printed name)	Signature	Date

Holtz, Holtz & Volek PC

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> PATENT REEL: 055961 FRAME: 0195

RECORDED: 04/19/2021